



# Dual N-Channel 40 V (D-S) MOSFET

PRODUCT SUMMARY						
V <sub>DS</sub> (V)	$R_{DS(on)}(\Omega)$	I <sub>D</sub> (A) <sup>a</sup>	Q <sub>g</sub> (Typ.)			
40	0.0325 at V <sub>GS</sub> = 10 V	7	3.3 nC			
40	0.040 at V <sub>GS</sub> = 4.5 V	6.3	3.3110			

# **SO-8** $D_1$ G<sub>1</sub> $D_1$ $D_2$ $D_2$ $G_2$ Top View

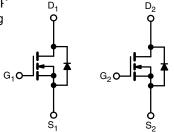
#### **FEATURES**

- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET® Gen III Power MOSFET
- 100 % R<sub>q</sub> Tested
- 100 % UIS Tested
- Compliant to RoHS Directive 2002/95/EC

# **RoHS** COMPLIANT **HALOGEN** FREE

### **APPLICATIONS**

- DC/DC Converter
  - External HDD
  - Notebook System F
- LCD Display Backlig



N-Channel MOSFET N-Channel MOSFET

Ordering Information: Si4286DY-T1-GE3	(Lead (Pb)-free and Halogen-free)

Parameter	Symbol	Limit	Unit	
Drain-Source Voltage Gate-Source Voltage		V <sub>DS</sub>	40 ± 20	V
		V <sub>GS</sub>		v
	T <sub>C</sub> = 25 °C		7	
Continuous Drain Current (T = 150 °C)	T <sub>C</sub> = 70 °C		5.6	
Continuous Drain Current (T <sub>J</sub> = 150 °C)	T <sub>A</sub> = 25 °C	I <sub>D</sub>	5.7 <sup>b, c</sup>	
	T <sub>A</sub> = 70 °C		4.6 <sup>b, c</sup>	
Pulsed Drain Current (t = 300 μs)		I <sub>DM</sub>	20	A
Continuous Source-Drain Diode Current	T <sub>C</sub> = 25 °C		2.4	
Continuous Source-Drain Diode Current	T <sub>A</sub> = 25 °C	ls –	1.6 <sup>b, c</sup>	
Single Pulse Avalanche Current	L = 0.1 mH	I <sub>AS</sub>	8	
Single Pulse Avalanche Energy		E <sub>AS</sub>	3.2	mJ
	T <sub>C</sub> = 25 °C		2.9	
Manipular Davida Disabation	T <sub>C</sub> = 70 °C		1.86	W
Maximum Power Dissipation	T <sub>A</sub> = 25 °C	P <sub>D</sub>	1.9 <sup>b, c</sup>	VV
	T <sub>A</sub> = 70 °C	1	1.23 <sup>b, c</sup>	
Operating Junction and Storage Temperature	T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	°C	

THERMAL RESISTANCE RATINGS							
Parameter	Symbol	Typical	Maximum	Unit			
Maximum Junction-to-Ambient <sup>b, d</sup>	t ≤ 10 s	R <sub>thJA</sub>	55	65	°C/W		
Maximum Junction-to-Foot (Drain)	Steady State	R <sub>thJF</sub>	35	43	C/VV		

#### Notes:

- a. Package limited.
- b. Surface mounted on 1" x 1" FR4 board.
- c. t = 10 s.
- d. Maximum under steady state conditions is 120 °C/W.

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static	Зушьог	rest conditions	IVIII.	Typ.	IVIAX.	Ollic	
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub> = 0, I <sub>D</sub> = 250 μA	40			V	
V <sub>DS</sub> Temperature Coefficient	ΔV <sub>DS</sub> /T <sub>J</sub>	VGS = 0, 1D = 230 μA	40	51		mV/°C	
V <sub>GS(th)</sub> Temperature Coefficient	+	$I_D = 250 \mu A$		- 5			
Gate-Source Threshold Voltage	$\Delta V_{GS(th)}/T_J$	$V_{DS} = V_{GS}$ , $I_D = 250 \mu A$	1.0	- 3	2.5	V	
	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_D = 250 \mu\text{A}$ $V_{DS} = 0 \text{V}$ , $V_{GS} = \pm 20 \text{V}$	1.0		± 100	-	
Gate-Source Leakage	I <sub>GSS</sub>				nA		
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS} = 40 \text{ V}, V_{GS} = 0 \text{ V}$			1 μA		
On-State Drain Current <sup>a</sup>	1	$V_{DS} = 40 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 \text{ °C}$ $V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	10		10	Α	
On-State Diam Current	I <sub>D(on)</sub>		10	0.007	0.0005	A	
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	$V_{GS} = 10 \text{ V, } I_D = 8 \text{ A}$		0.027	0.0325	Ω	
Forward Transpoordingtones		$V_{GS} = 4.5 \text{ V}, I_D = 5 \text{ A}$		0.033	0.040	C	
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 8 A		27		S	
Dynamic <sup>b</sup>				075		l	
Input Capacitance	C <sub>iss</sub>			375		pF	
Output Capacitance	C <sub>oss</sub>	$V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		67			
Reverse Transfer Capacitance	C <sub>rss</sub>			29			
Total Gate Charge	Q <sub>g</sub>	$V_{DS} = 20 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 8 \text{ A}$		6.8	10.5	nC	
Cata Causa Chausa	Ů	V 00 V V 45 V L 0 A		3.3	5		
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS} = 20 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 8 \text{ A}$		1			
Gate-Drain Charge	Q <sub>gd</sub>	£ 4 NALL-	0.0	1.1	7.4	0	
Gate Resistance	R <sub>g</sub>	f = 1 MHz	0.8	3.7	7.4	Ω	
Turn-On Delay Time	t <sub>d(on)</sub>			33	60	-	
Rise Time	t <sub>r</sub>	$V_{DD}$ = 20 V, $R_L$ = 2.5 $\Omega$ $I_D \approx 8$ A, $V_{GEN}$ = 4.5 V, $R_q$ = 1 $\Omega$		60	110		
Turn-Off Delay Time	t <sub>d(off)</sub>	$ID = 0 A$ , $V_{GEN} - 4.3 V$ , $II_g - 1.52$		17	34		
Fall Time	t <sub>f</sub>			22	40	ns	
Turn-On Delay Time	t <sub>d(on)</sub>			9	18		
Rise Time	t <sub>r</sub>	$V_{DD} = 20 \text{ V}, R_L = 2.5 \Omega$		11	22		
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \approx 8 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$		10	20		
Fall Time	t <sub>f</sub>			7	14		
Drain-Source Body Diode Characteristi				1	1	Τ	
Continuous Source-Drain Diode Current	I <sub>S</sub>	T <sub>C</sub> = 25 °C			2.4	Α	
Pulse Diode Forward Current	I <sub>SM</sub>				20		
Body Diode Voltage	$V_{SD}$	$I_S = 3 A, V_{GS} = 0$		0.8	1.2	V	
Body Diode Reverse Recovery Time	t <sub>rr</sub>			13	26	ns	
Body Diode Reverse Recovery Charge	$Q_{rr}$	I <sub>F</sub> = 5 A, dI/dt = 100 A/μs, T <sub>.I</sub> = 25 °C		6	12	nC	
Reverse Recovery Fall Time	t <sub>a</sub>			7		ns	
Reverse Recovery Rise Time	t <sub>b</sub>			6		115	

#### Notes:

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

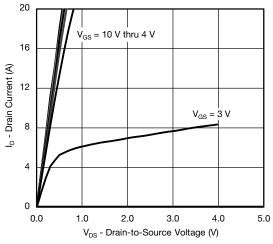
a. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 %.

b. Guaranteed by design, not subject to production testing.

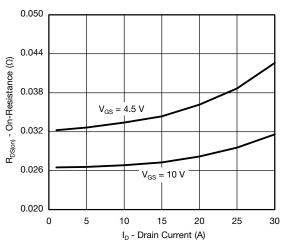




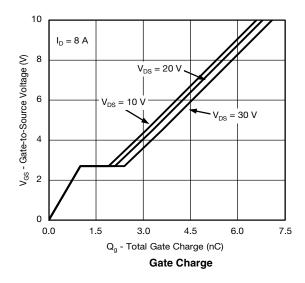
## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

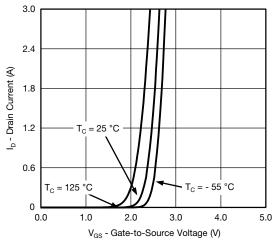


### **Output Characteristics**

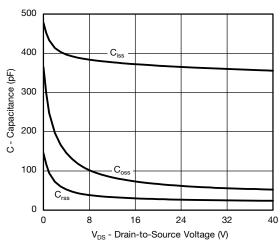


On-Resistance vs. Drain Current

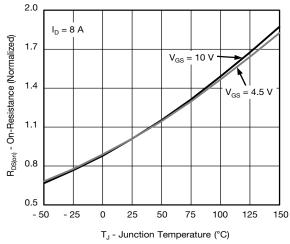




**Transfer Characteristics** 



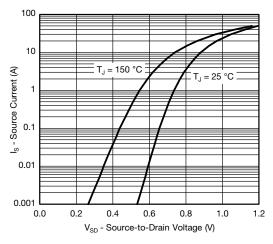
Capacitance



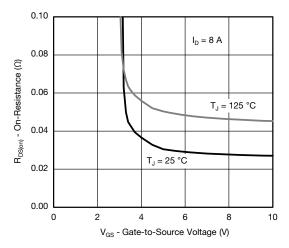
On-Resistance vs. Junction Temperature

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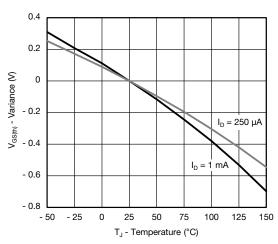
### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



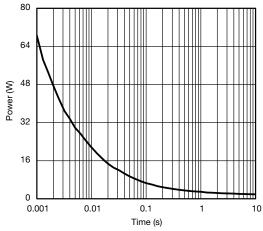
#### Source-Drain Diode Forward Voltage



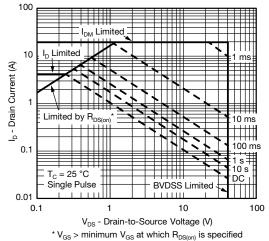
On-Resistance vs. Gate-to-Source Voltage







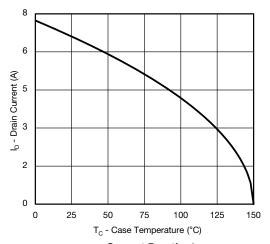
**Single Pulse Power** 



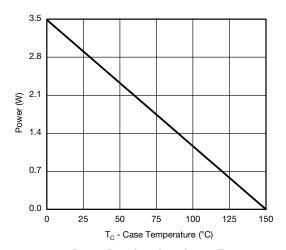
Safe Operating Area, Junction-to-Ambient

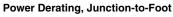


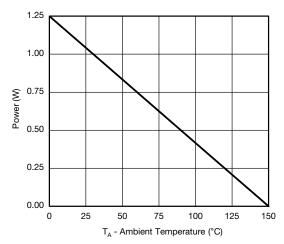
### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



# **Current Derating\***





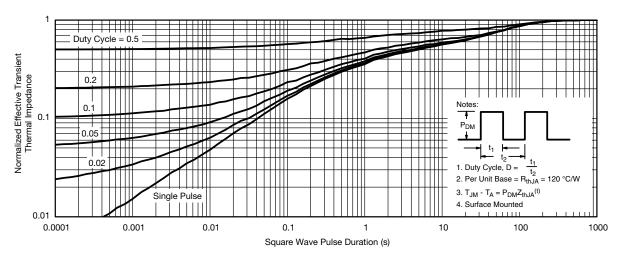


Power Derating, Junction-to-Ambient

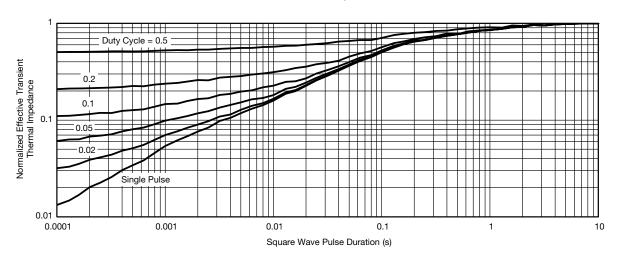
<sup>\*</sup> The power dissipation  $P_D$  is based on  $T_{J(max)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



#### Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?67599.



SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012







	MILLIM	IETERS	INCHES		
DIM	Min	Max	Min	Max	
Α	1.35	1.75	0.053	0.069	
A <sub>1</sub>	0.10	0.20	0.004	0.008	
В	0.35	0.51	0.014	0.020	
С	0.19	0.25	0.0075	0.010	
D	4.80	5.00	0.189	0.196	
Е	3.80	4.00	0.150	0.157	
е	1.27	BSC	0.050 BSC		
Н	5.80	6.20	0.228	0.244	
h	0.25	0.50	0.010	0.020	
L	0.50	0.93	0.020	0.037	
q	0°	8°	0°	8°	
S	0.44	0.64	0.018	0.026	
ECN: C-06527-Rev. I. 11-Sep-06					

DWG: 5498

Document Number: 71192 www.vishay.com 11-Sep-06



### **RECOMMENDED MINIMUM PADS FOR SO-8**



Recommended Minimum Pads Dimensions in Inches/(mm)

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